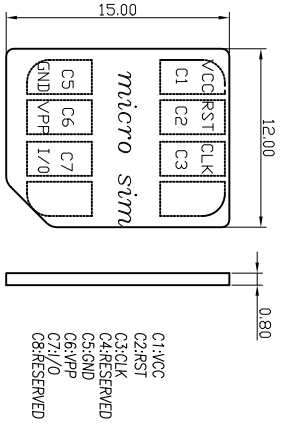
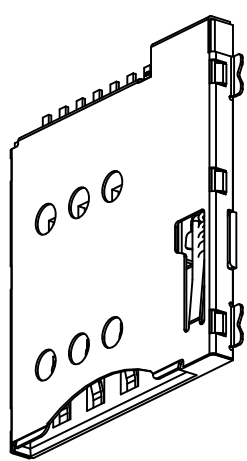
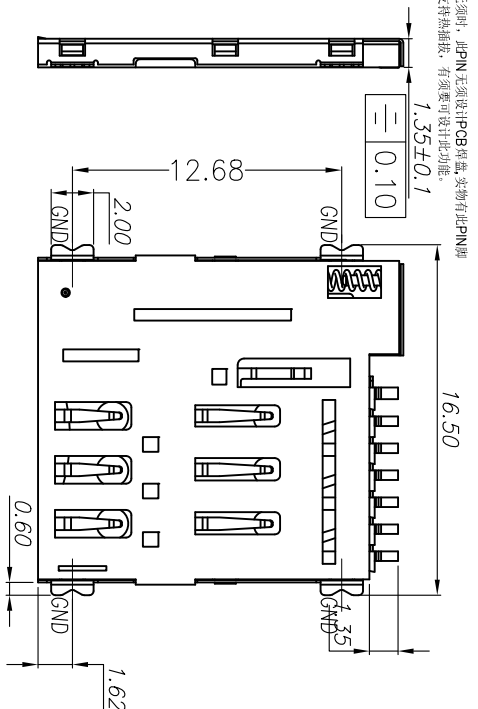
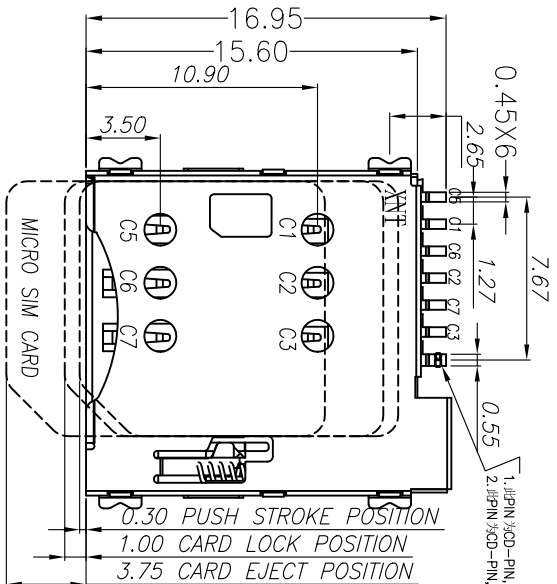
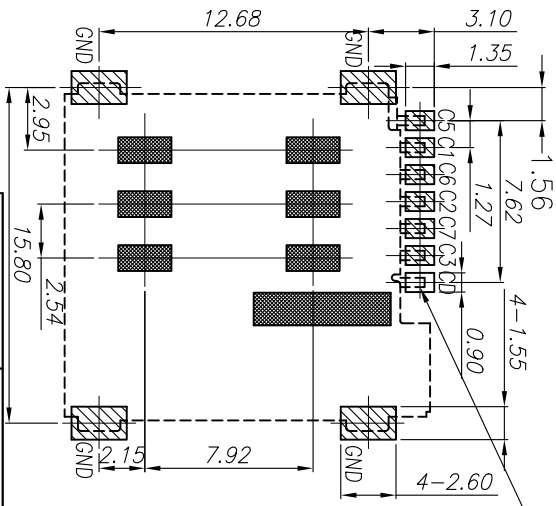
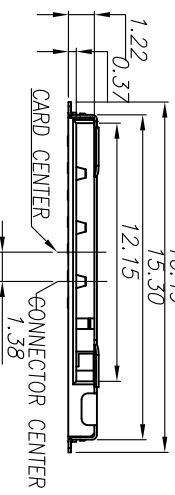


REV	DESCRIPTION	ECN NO	DATE



- C1:VCC
- C2:RST
- C3:CLK
- C4:RESERVED
- C5:GND
- C6:VPP
- C7:I/O
- 08:RESERVED



1. 此PIN为CD-PIN, 此PIN无须时不需要设计PCB焊盘。
 2. 此PIN为CD-PIN, 支持热插拔, 有须要可设计此功能。

Specification

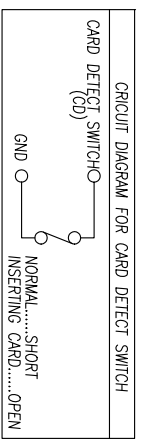
MATERIAL:
 Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy

PLATING:
 Contact: Plated 50μ Ni Overall
 Shell: Plated 50μ Ni Overall
 Plated 1μ Au Selective Contact Area

Electrical:
 Current Rating : 0.5mA AC/DC max.
 Voltage Rating : 125V AC/DC
 Ambient Temperature Range : -20°C ~ +60°C
 Storage Temperature Range : -40°C ~ +70°C
 Ambient Humidity Range : 95% R.H. Max.
 Contact Resistance: 100mΩ max.
 Insulation Resistance: 1000MΩ min./500VΩ
 Mating Cycles: 10,000 Insertions
 产品耐温温度: 200°C (C1, S1, 200°C; C1, S1, 200°C)

■ CIRCUIT TRACE KEEP OUT AREA
 ■ SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES
 IN THE LAYOUT SPACE OF THE PRODUCTS.
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



JIXING TECHNOLOGY CO., LTD

GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE
MM ONLY	
XX	DRAWN BY: Frank
±0.25	CHECKED BY: DATE
XX	DATE 11-7-9
±0.15	PART NO:
XX	DATE
±0.05	THIRD ANGLE PROJECTION

TITLE: MICRO-SIM 卡座PUSH/PUSH 1.35H 带CD PIN XNT Edition
PART NO: SIM-019
SIZE: A4
SCALE: ---
SHEET NO: 1 OF 1